

System Lens Drivers

μ -step System Lens Driver for Digital Still Cameras


BU24024GU
General Description

BU24024GU is a system Lens Driver that uses μ -step driving to make the configuration of the sophisticated, high precision and low noise lens driver system possible. This IC has a built-in driver for both DC motor and voice coil motor and a μ -step controller that decreases CPU power. Therefore, multifunctional lens can be applied.

Features

- Built-in 7 channels Driver block
 - 1ch-5ch: Voltage control type H-bridge (Adaptable to STM 2systems)
 - 6,7ch: Current control type H-bridge
- Built-in 2 channels PI driving circuit

Applications

- Digital still cameras

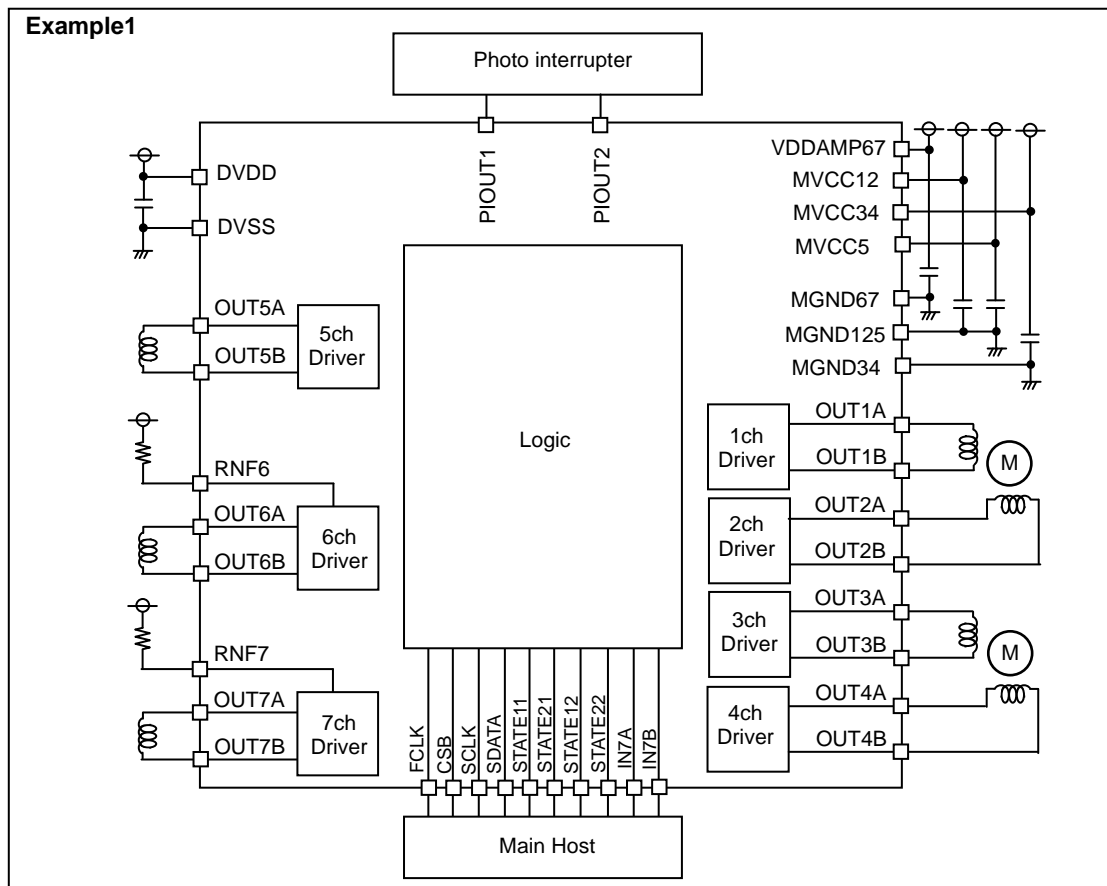
Typical Application Circuit
Key Specifications

- Digital Power Supply Voltage: 2.7V to 3.6V
- Driver Power Supply Voltage: 2.7V to 5.5V
- Output Current (1ch-4ch,6ch,7ch): $\pm 400\text{mA}(\text{Max})$
- Output Current (5ch): $\pm 600\text{mA}(\text{Max})$
- Input Clock Frequency: 1MHz to 27.5MHz
- FET ON Resistance (1ch-5ch): $1.5\Omega(\text{Typ})$
- FET ON Resistance (6ch,7ch): $1.1\Omega(\text{Typ})$
- Operating Temperature Range: -20°C to $+85^{\circ}\text{C}$

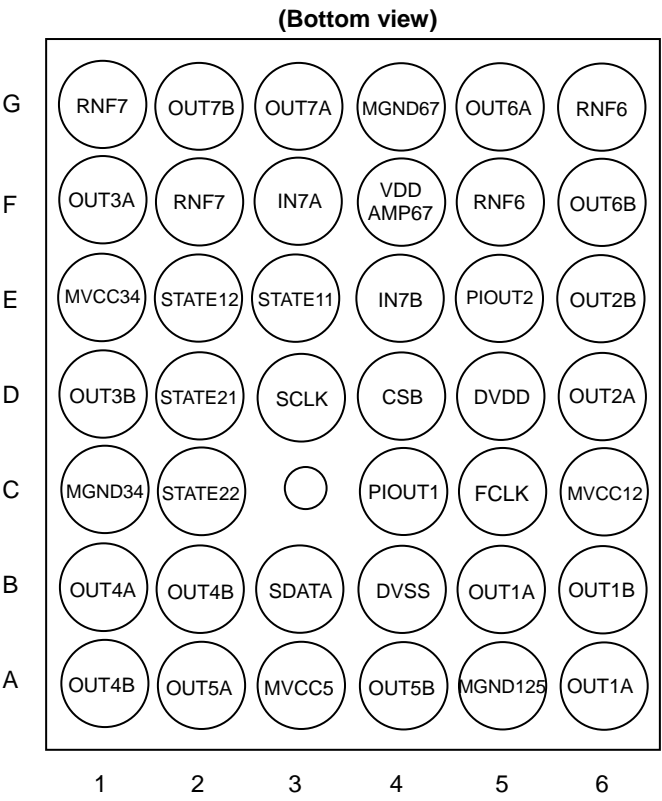
Package

VCSP85H3

3.50mm x 3.60mm x 1.00mm



●Pin Configuration

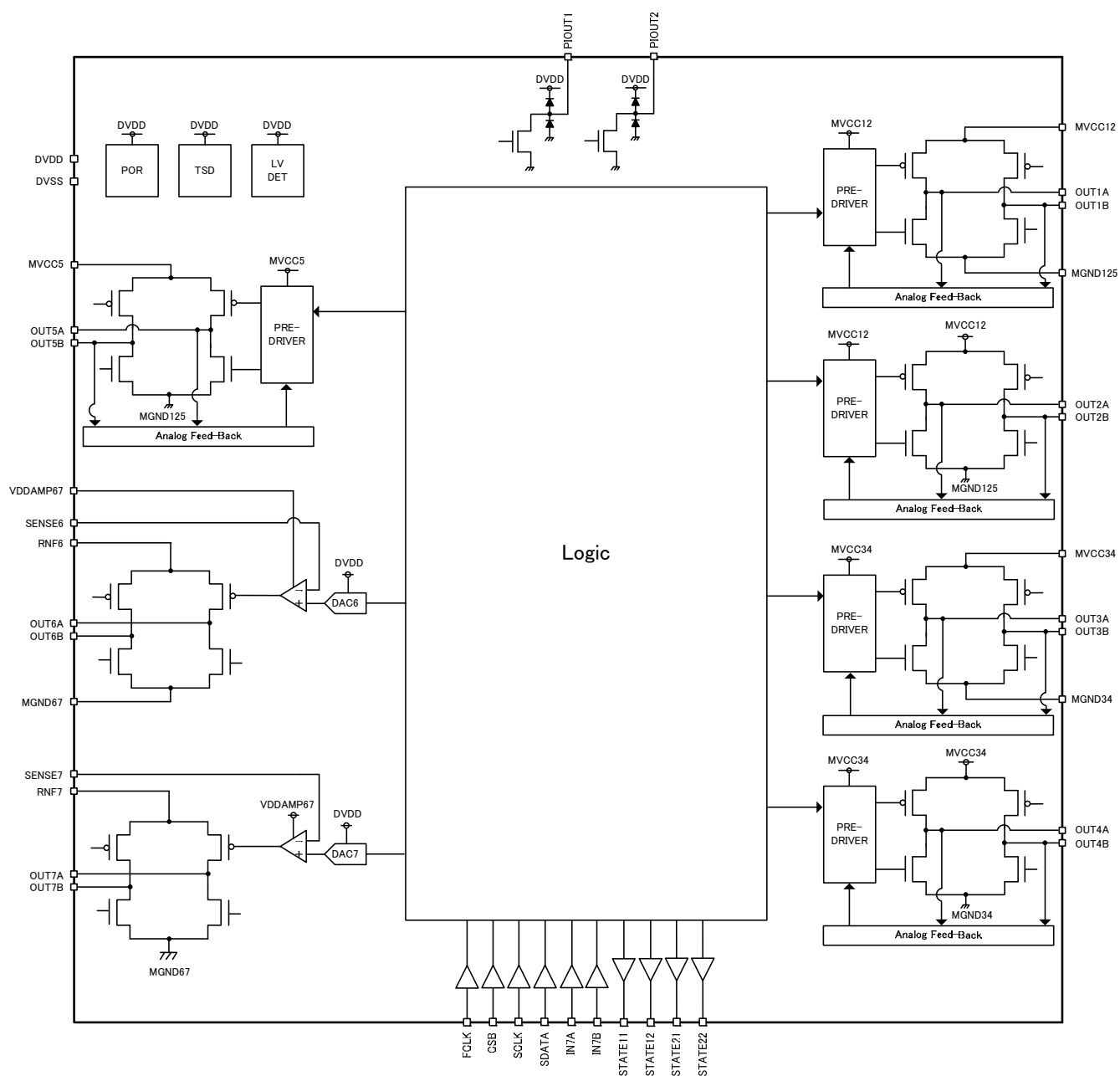


●Pin Description

| Land Matrix No. | Pin Name | Power Supply | Function | Land Matrix No. | Pin Name | Power Supply | Function |
|-----------------|----------|--------------|--------------------------------|-----------------|----------|--------------|---|
| D5 | DVDD | - | Digital power supply | E6 | OUT2B | MVCC12 | 2-channel driver B output |
| B4 | DVSS | - | Digital ground | E1 | MVCC34 | - | 3-4channel driver power supply |
| C5 | FCLK | DVDD | FCLK logic input | C1 | MGND34 | - | 3-4channel driver ground |
| D4 | CSB | DVDD | CSB logic input | F1 | OUT3A | MVCC34 | 3-channel driver A output |
| D3 | SCLK | DVDD | SCLK logic input | D1 | OUT3B | MVCC34 | 3-channel driver B output |
| B3 | SDATA | DVDD | SDATA logic input | B1 | OUT4A | MVCC34 | 4-channel driver A output |
| F3 | IN7A | DVDD | IN7A logic input | A1, B2(*) | OUT4B | MVCC34 | 4-channel driver B output |
| E4 | IN7B | DVDD | IN7B logic input | A3 | MVCC5 | - | 5-channel driver power supply |
| E3 | STATE11 | DVDD | STATE11 logic output | A2 | OUT5A | MVCC5 | 5-channel driver A output |
| E2 | STATE12 | DVDD | STATE12 logic output | A4 | OUT5B | MVCC5 | 5-channel driver B output |
| D2 | STATE21 | DVDD | STATE21 logic output | F4 | VDDAMP67 | - | Power supply of 6-7channel current driver control |
| C2 | STATE22 | DVDD | STATE22 logic output | F5, G6(*) | RNF6 | - | 6-channel driver power supply |
| C4 | PIOUT1 | DVDD | PI driving output1 | G4 | MGND67 | - | 6-7channel driver ground |
| E5 | PIOUT2 | DVDD | PI driving output2 | G5 | OUT6A | RNF6 | 6-channel driver A output |
| C6 | MVCC12 | - | 1-2channel driver power supply | F6 | OUT6B | RNF6 | 6-channel driver B output |
| A5 | MGND125 | - | 1-2, 5channel driver ground | F2, G1(*) | RNF7 | - | 7-channel driver power supply |
| A6, B5(*) | OUT1A | MVCC12 | 1-channel driver A output | G3 | OUT7A | RNF7 | 7-channel driver A output |
| B6 | OUT1B | MVCC12 | 1-channel driver B output | G2 | OUT7B | RNF7 | 7-channel driver B output |
| D6 | OUT2A | MVCC12 | 2-channel driver A output | | | | |

(*)It is not possible to use corner pin only (Corner pins are A1, A6, G1 and G6.).
Please short A1-B2, A6-B5, F2-G1, F5-G6 or use B2, B5, F2, F5 only.

●Block Diagram



●Description of Blocks

Stepping Motor Driver (1ch-4ch Driver)

Built-in stepping motor driver of PWM driving type.

Maximum 2 stepping motors can be driven independently.

Built-in voltage feedback circuit of D-class type.

3ch/4ch drivers can also drive independently for DC motor or voice coil motor.

(1)Control

(i) Autonomous Control

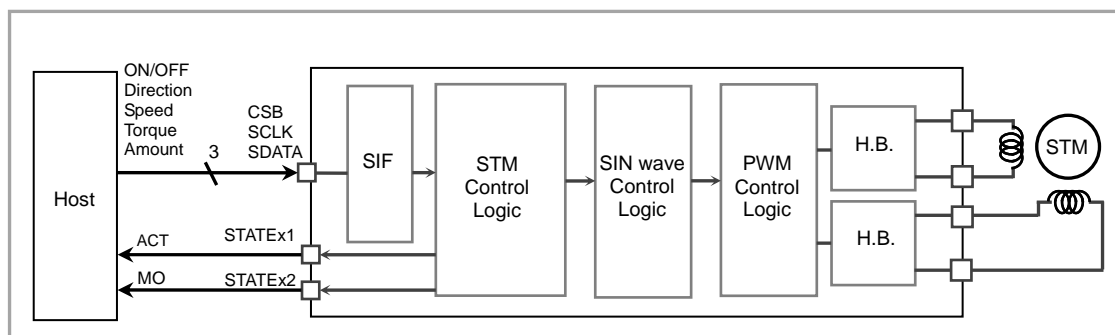
The stepping motor is rotated by setting the registers for the stepping motor control.

It is possible to select the mode of stepping motor control from μ -step (1024 portion), 1-2 phase excitation and 2 phase excitation

Built-in Cache registers.

Cache registers enable the setting of subsequent process while the motor is in operation. Through these registers operations are done continuously.

The state of the rotation command (ACT), state of Cache registers (BUSY), motor operation position (MO) and state of excitation (MO & ACT) are synchronized with the motor rotation and can be selected to be the output of the STATE pin.



●Description of Blocks

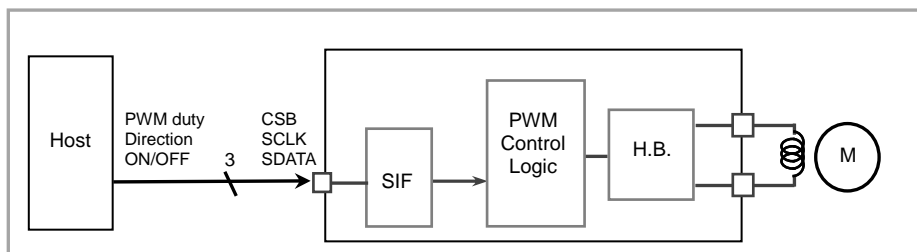
Voltage Driver (5ch Driver)

Built-in voltage driver of PWM driving type.

(1) Control

(i) Register Control

The PWM drive is executed by the PWM duty ratio, the PWM direction and the PWM ON/OFF which are controlled by the register settings.



Current Driver (6ch Driver)

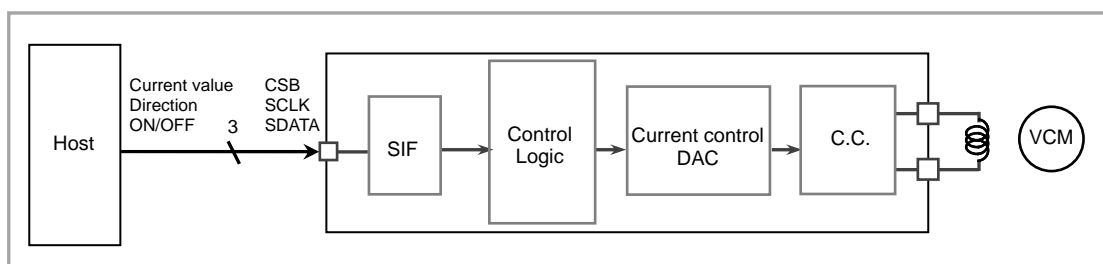
Built-in constant current driver.

The voltage of RNF pin and the external resistor (RRNF) determine the amount of output current. The internal high-precision amplifier (CMOS gate input) is used for constant current control. If any resistance component exists in the wirings of RNF pin and the external resistor (RRNF), the precision can be reduced. To avoid this, pay utmost attention to the wirings.

(1) Control

(i) Register Control

The constant current drive is executed by the output current value, the current direction and the current ON/OFF which are controlled by the register settings.



●Description of Blocks

Current Driver (7ch Driver)

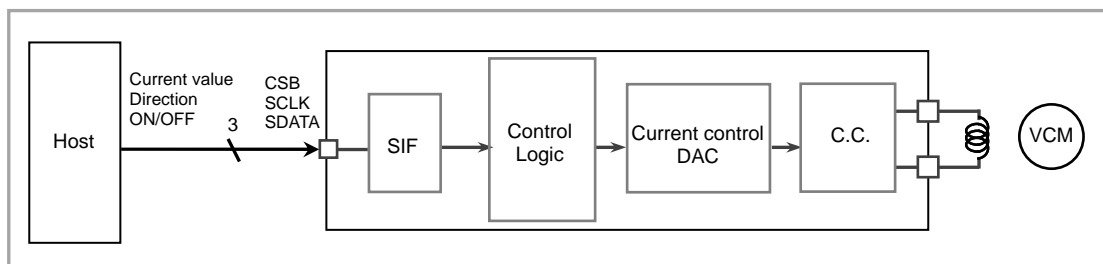
Built-in constant current driver.

The voltage of RNF pin and the external resistor (RRNF) determine the amount of output current. The internal high-precision amplifier (CMOS gate input) is used for constant current control. If any resistance component exists in the wirings of RNF pin and the external resistor (RRNF), the precision can be reduced. To avoid this, pay utmost attention to the wirings.

(1) Control

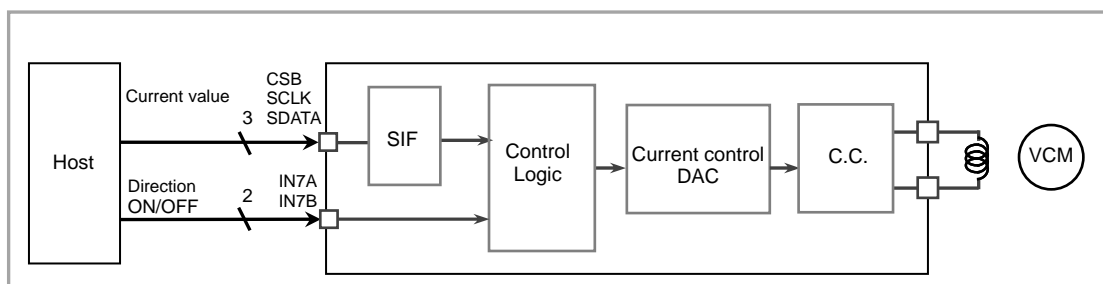
(i) Register Control

The constant current drive is executed by the output current value, the current direction and the current ON/OFF which are controlled by the register settings.



(ii) External Pin Control

The constant current drive is executed by the output current value which is controlled by the register setting. Constant current driving direction and turning ON/OFF are controlled by IN7A/IN7B pin.



●Absolute Maximum Ratings(Ta=25°C)

| Parameter | Symbol | Limit | Unit | Remark |
|---------------------------------------|--------|----------------------------|------|-----------------------------------|
| Power Supply Voltage | DVDD | -0.3 to +4.5 | V | |
| | MVCC | -0.3 to +7.0 | V | |
| Input Voltage | VIN | -0.3 to supply voltage+0.3 | V | |
| Input / Output Current ^{*1} | IIN | ±400 | mA | MVCC12, MVCC34, RNF6 and RNF7 pin |
| | | ±600 | mA | MVCC5 |
| | | +50 | mA | By P1OUT pin |
| Storage Temperature Range | TSTG | -55 to +125 | °C | |
| Operating Temperature Range | TOPE | -20 to +85 | °C | |
| Permissible Dissipation ^{*2} | PD | 1200 | mW | |

^{*1} Must not exceed PD.

^{*2} To use at a temperature higher than Ta=25 °C, derate 12mW per 1 °C
(At mounting 50mm x 58mm x 1.75mm glass epoxy board.)

●Recommended Operating Rating (Ta=25°C)

| Parameter | Symbol | Limit | Unit | Remark |
|------------------------------|--------|------------|------|-----------------|
| Digital Power Supply Voltage | DVDD | 2.7 to 3.6 | V | DVDD ≤ MVCC |
| Driver Power Supply Voltage | MVCC | 2.7 to 5.5 | V | |
| Clock Operating Frequency | FCLK | 1 to 27.5 | MHz | Reference clock |

●Electrical Characteristics

(Unless otherwise specified, Ta=25°C, DVDD=3.0V, MVCC=5.0V, DVSS=MGND=0.0V)

| Parameter | Symbol | Limit | | | Unit | Conditions |
|--|--------|---------|------|---------|------|--|
| | | MIN | TYP | MAX | | |
| <Current Consumption> | | | | | | |
| Quiescence (DVDD) | ISSD | - | 0.45 | 1.5 | mA | CMD_RS=0 |
| | (MVCC) | ISSVM | - | 50 | μ A | |
| Operation (DVDD) | IDDD | - | 6 | 10 | mA | |
| <Logic Block> | | | | | | |
| Low-level Input Voltage | VIL | DVSS | - | 0.3DVDD | V | |
| High-level Input Voltage | VIH | 0.7DVDD | - | DVDD | V | |
| Low-level Input Current | IIL | 0 | - | 10 | μ A | VIL=DVSS |
| High-level Input Current | IIH | 0 | - | 10 | μ A | VIH=DVDD |
| Low-level Output Voltage | VOL | DVSS | - | 0.2DVDD | V | IOL=1.0mA |
| High-level Output Voltage | VOH | 0.8DVDD | - | DVDD | V | IOH=1.0mA |
| <PI Driving Circuit> | | | | | | |
| Output Voltage | PIVO | - | 0.16 | 0.50 | V | IIH=30mA |
| <Voltage Driver Block 1ch-4ch> | | | | | | |
| ON-resistance | Ron | - | 1.5 | 2.0 | Ω | IO=±100mA (the sum of high and low sides) |
| OFF-leak Current | IOZ | -10 | 0 | +10 | μ A | Output Hiz setting |
| Average Voltage Accuracy between different Output Pins | Vdiff | -5 | - | +5 | % | Vdiff setting : 2Bh |
| <Current Driver Block 5ch,6ch> | | | | | | |
| ON-resistance | Ron | - | 1.1 | 1.5 | Ω | IO=±100mA (the sum of high and low sides) |
| OFF-leak Current | IOZ | -10 | 0 | +10 | μ A | Output Hiz setting |
| Output Current | IO | 190 | 200 | 210 | mA | DAC setting : 80h RRNF=1Ω |

●Typical Performance Curves

(Unless otherwise specified, Ta=25°C, DVDD=3.0V, MVCC=5.0V, DVSS=MGND=0.0V)

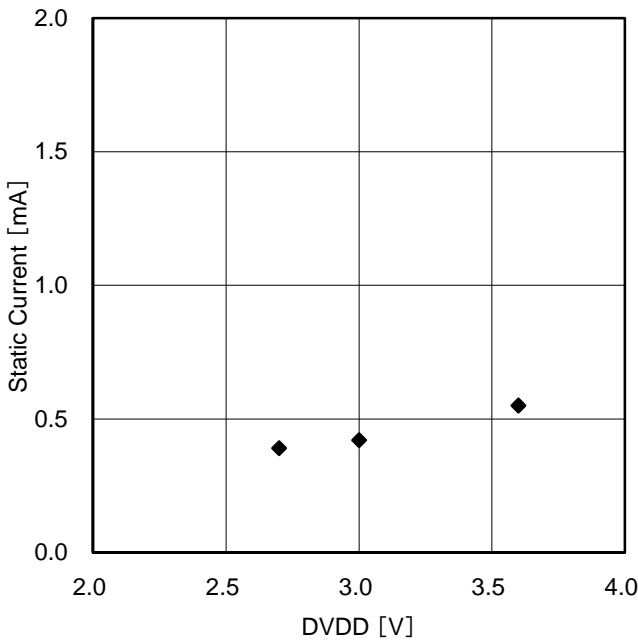


Figure 1. DVDD Static Current
Voltage Dependency

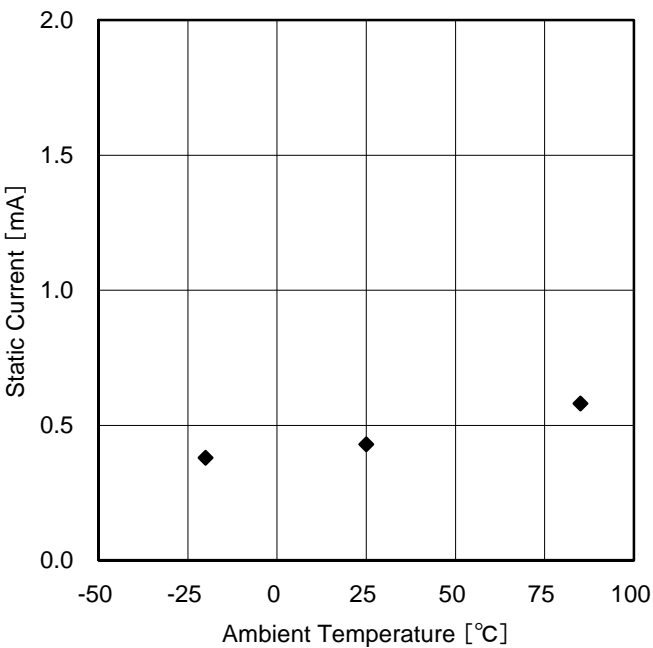


Figure 2. DVDD Static Current
Temperature Dependency

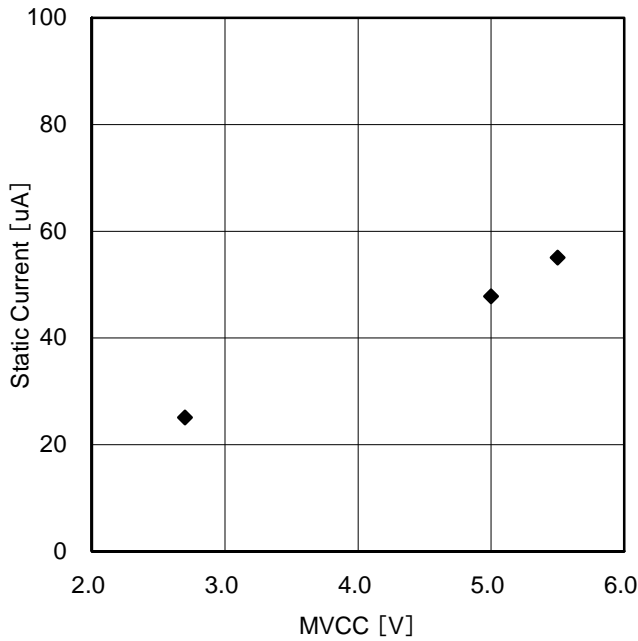


Figure 3. MVCC Static Current
Voltage Dependency

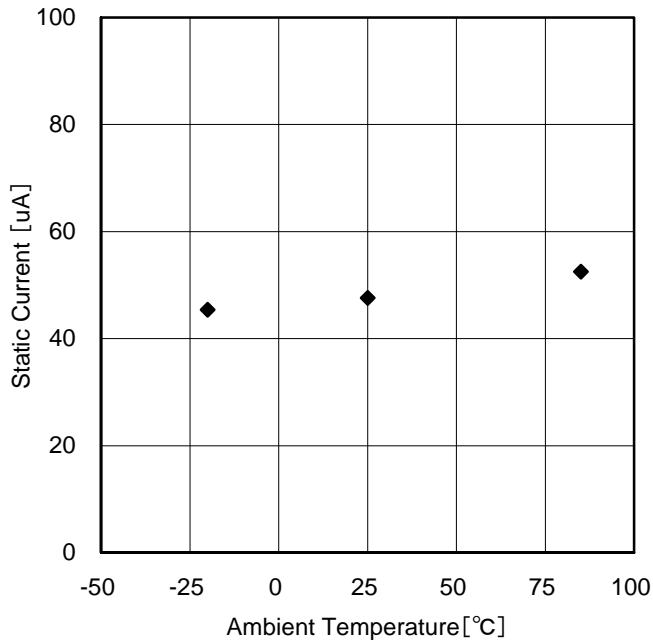


Figure 4. MVCC Static Current
Temperature Dependency

●Typical Performance Curves
(Unless otherwise specified, Ta=25°C, DVDD=3.0V, MVCC=5.0V, DVSS=MGND=0.0V)

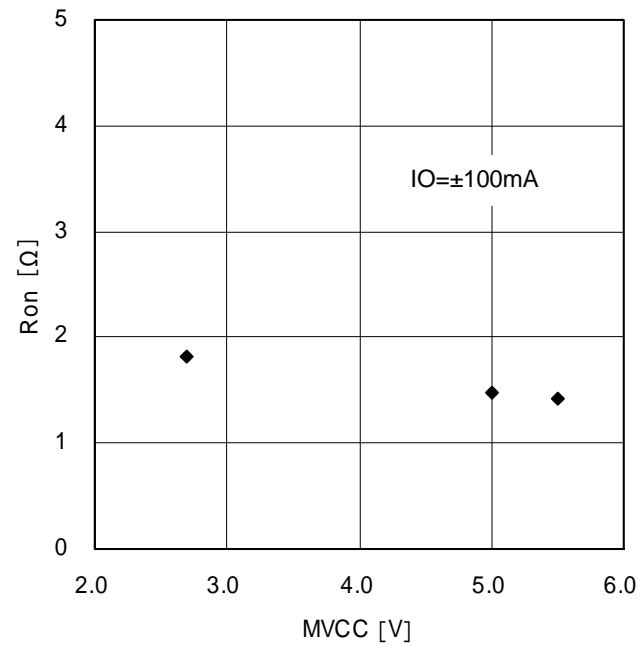


Figure 5. Output ON-Resistance
MVCC Dependency
(Voltage driver block)

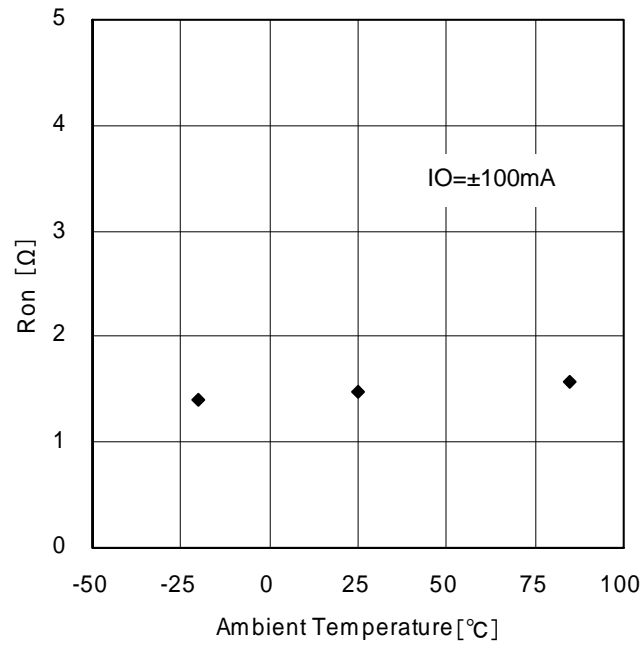


Figure 6. Output ON-Resistance
Temperature Dependency
(Voltage driver block)

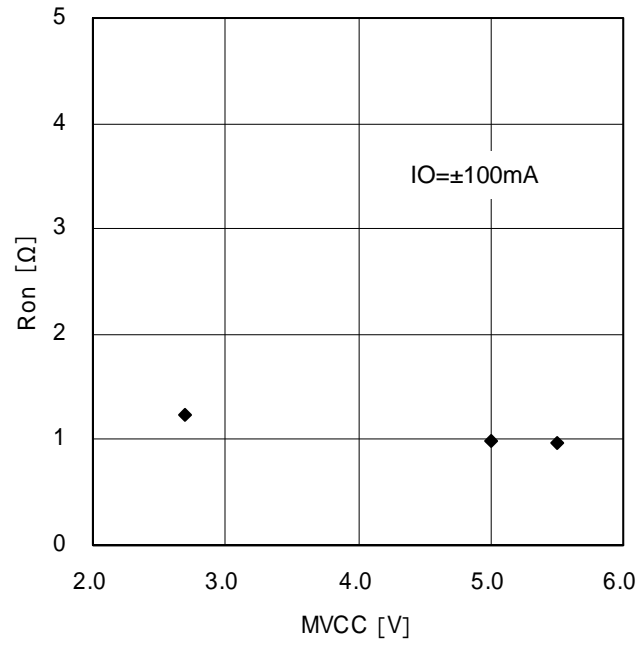


Figure 7. Output ON-Resistance
MVCC Dependency
(Current driver block)

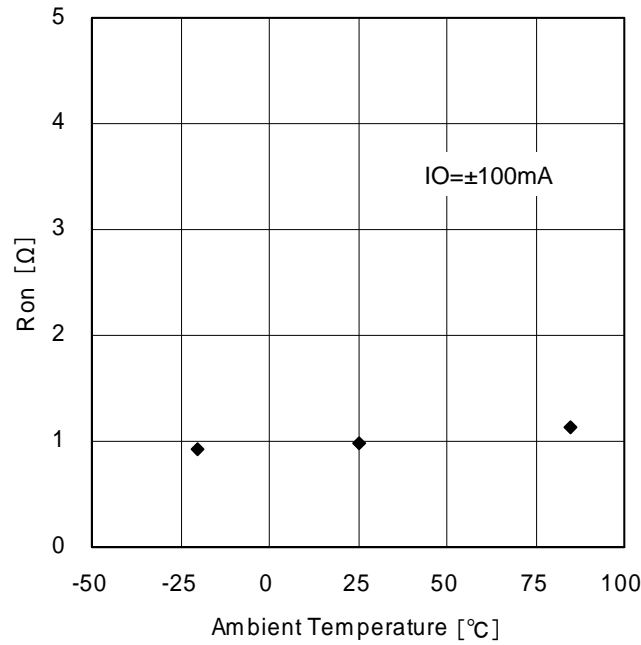


Figure 8. Output ON-Resistance
Temperature Dependency
(Current driver block)

● Typical Performance Curves

(Unless otherwise specified, $T_a=25^{\circ}\text{C}$, $\text{DVDD}=3.0\text{V}$, $\text{MVCC}=5.0\text{V}$, $\text{DVSS}=\text{MGND}=0.0\text{V}$)

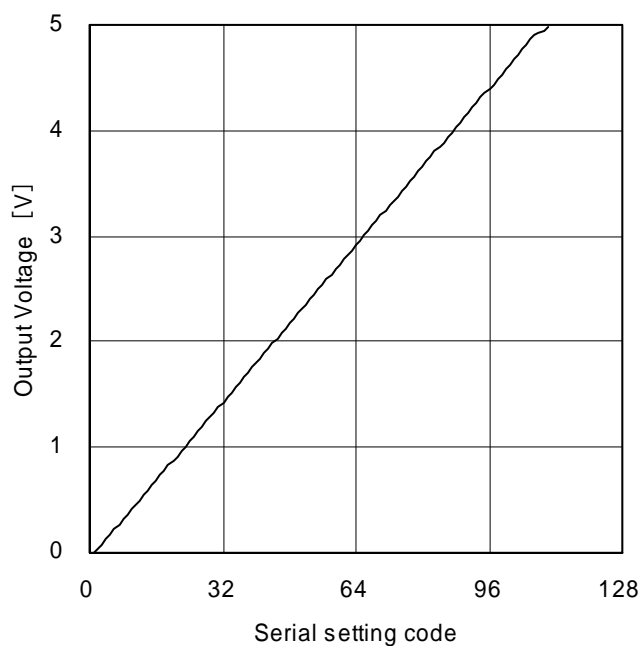


Figure 9. Average Voltage Accuracy
between different output pins
(Voltage driver block)

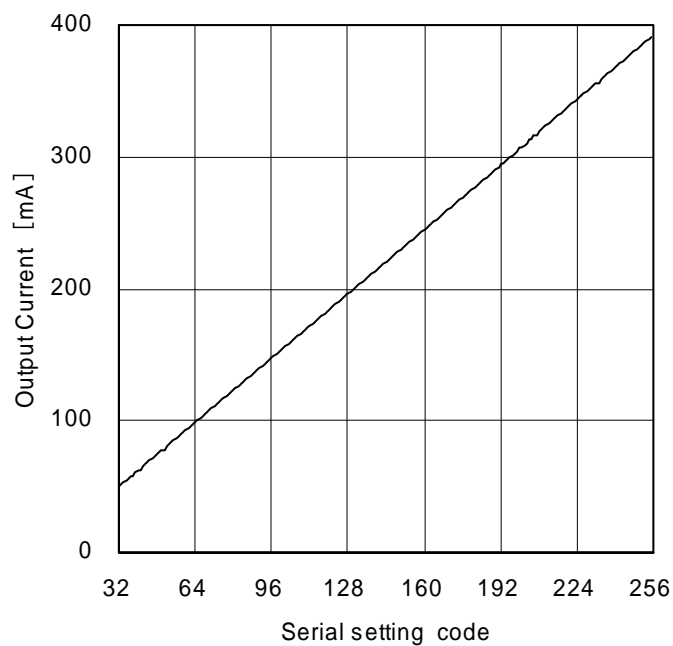


Figure 10. Output Current
(Current driver block, $\text{RRNF} = 1.0\Omega$, $\text{RL} = 5.0\Omega$)

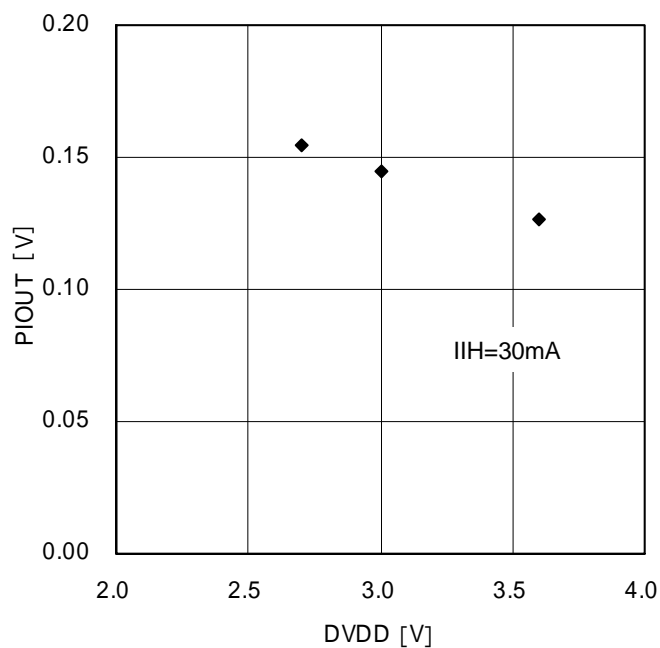


Figure 11. Output Voltage
DVDD Dependency
(PI driving circuit)

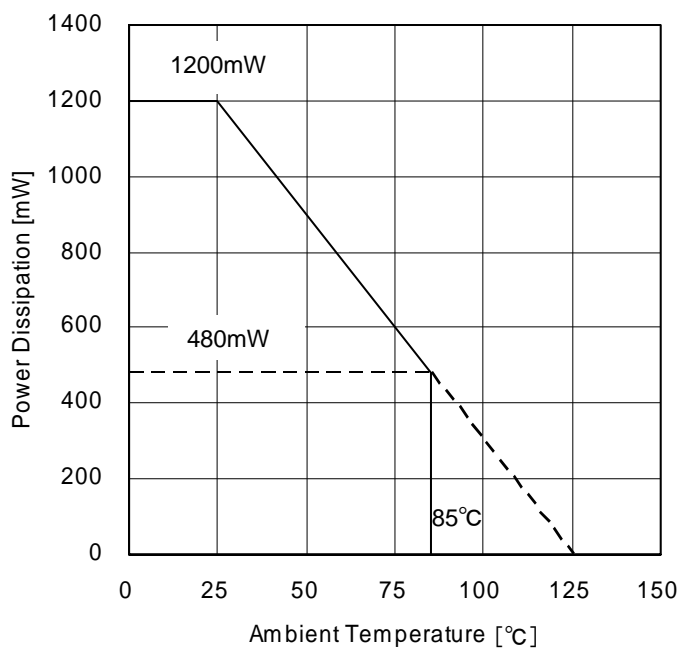
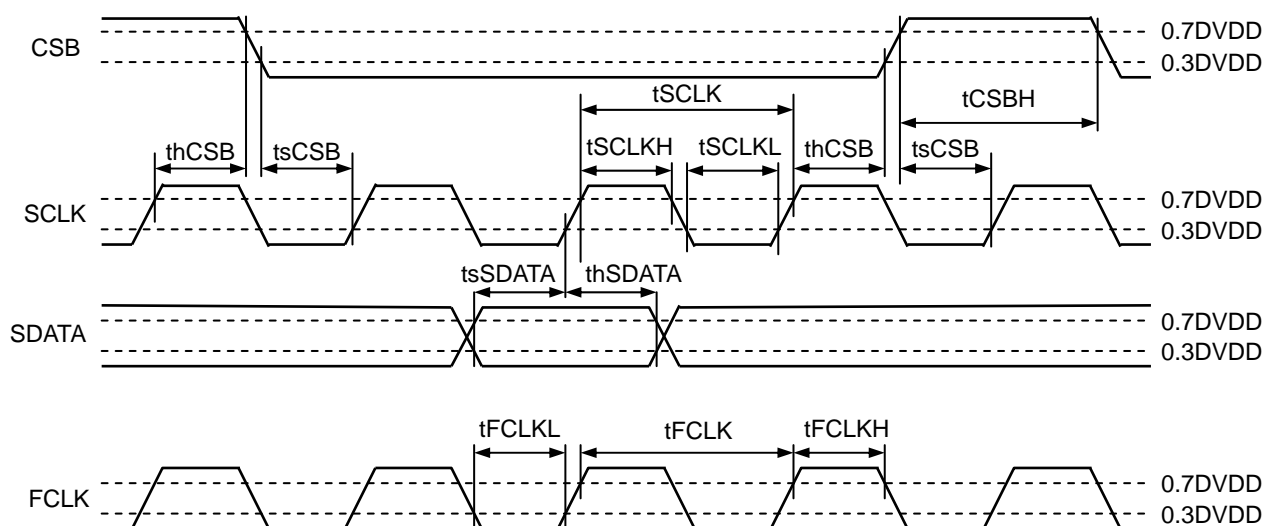


Figure 12. Power Dissipation Curve

●Timing Chart

(Unless otherwise specified, $T_a=25^{\circ}\text{C}$, $\text{DVDD}=3.0\text{V}$)

| Parameter | Symbol | Specification |
|-------------------------|--------|--------------------|
| SCLK input cycle | tSCLK | More than 125 nsec |
| SCLK L-level input time | tSCLKL | More than 50 nsec |
| SCLK H-level input time | tSCLKH | More than 50 nsec |
| SDATA setup time | tsDATA | More than 50 nsec |
| SDATA hold time | thDATA | More than 50 nsec |
| CSB H-level input time | tCSBH | More than 380 nsec |
| CSB setup time | tsCSB | More than 50 nsec |
| CSB hold time | thCSB | More than 50 nsec |
| FCLK input cycle | tFCLK | More than 36 nsec |
| FCLK L-level input time | tFCLKL | More than 18 nsec |
| FCLK H-level input time | tFCLKH | More than 18 nsec |

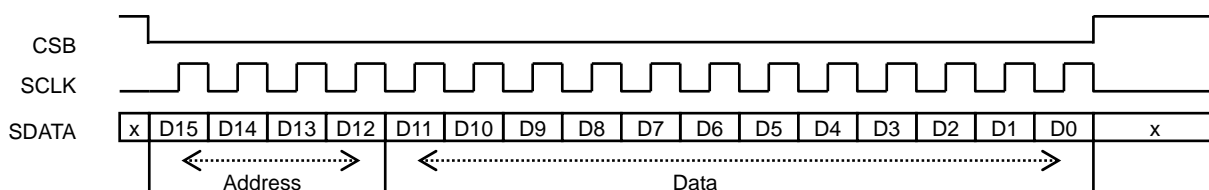


(note1) FCLK is asynchronous with SCLK.

(note2) Duty of FCLK, SCLK are free.

●Serial interface

Control commands are framed by a 16-bit serial input (MSB first) and are sent through the CSB, SCLK, and SDATA pins. The 4 higher-order bits specify addresses, while the remaining 12 bits specify data. Data of every bit is sent through SDATA pin, which is retrieved during the rising edge of SCLK. Data becomes valid when CSB is Low. The load timing is different for resistors. (as shown in "Note4, 5")



<Register map>

| Address[3:0] | | | | Data[11:0] | | | | | | | | | | | | |
|----------------------------------|----|----|----|--------------------|-----|----------------|---------------|--|-----------------------------------|---------------|-----------|------------|--------------|---------------|--------|-------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| 0 | 0 | 0 | 0 | ModeA[1:0] | | SelA[1:0] | | 0 | Ach_different_output_voltage[6:0] | | | | | | | |
| 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | Ach_Cycle[7:0] | | | | | | | | |
| | | | | 0 | 0 | 1 | 0 | Ach_Cycle[15:8] | | | | | | | | |
| | | | | 0 | 1 | 1 | 0 | A_BEXC | 0 | 0 | A_BSL | A_AEXC | 0 | 0 | A_AS_L | |
| | | | | 1 | 1 | 1 | 0 | 0 | 0 | APOS[1:0] | | 0 | 0 | 0 | ASTOP | |
| 0 | 0 | 1 | 0 | EnA | RtA | Ach_Pulse[9:0] | | | | | | | | | | |
| 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| 1 | 0 | 0 | 0 | ModeB[1:0] | | SelB[1:0] | | 0 | Bch_different_output_voltage[6:0] | | | | | | | |
| 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | Bch_Cycle[7:0] | | | | | | | | |
| | | | | 0 | 0 | 1 | 0 | Bch_Cycle[15:8] | | | | | | | | |
| | | | | 0 | 1 | 1 | 0 | B_BEXC | 0 | 0 | B_BSL | B_AEXC | 0 | 0 | B_AS_L | |
| | | | | 1 | 0 | 0 | 0 | 0 | 0 | 3_Chop[1:0] | | 0 | 0 | 4_Chop[1:0] | | |
| | | | | 1 | 0 | 1 | 3_PWM_Ct[1:0] | | 3ch_PWM_Duty[6:0] | | | | | | | |
| | | | | 1 | 1 | 0 | 4_PWM_Ct[1:0] | | 4ch_PWM_Duty[6:0] | | | | | | | |
| | | | | 1 | 1 | 1 | 0 | 0 | 0 | 0 | BPOS[1:0] | | 0 | 0 | 0 | BSTOP |
| 1 | 0 | 1 | 0 | EnB | RtB | Bch_Pulse[9:0] | | | | | | | | | | |
| 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| 1 | 1 | 0 | 0 | 0 | 0 | Chopping[1:0] | | CacheM | 0 | 0 | 0 | P_CTRL | CLK_DIV[2:0] | | | |
| 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | PI_CTRL1 | PI_CTRL2 | | |
| | | | | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 5_Sel[1:0] | | 5_Chop[1:0] | | |
| | | | | 0 | 1 | 0 | 5_PWM_Ct[1:0] | | 5ch_PWM_Duty[6:0] | | | | | | | |
| 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | Current driver reference voltage adjustment6 (DAC6 output value) [7:0] | | | | | | | | |
| | | | | 0 | 1 | 0 | 0 | 7ch_S | 0 | 7_PWM_Ct[1:0] | | 6ch_S | 0 | 6_PWM_Ct[1:0] | | |
| | | | | 1 | 0 | 0 | 0 | Current driver reference voltage adjustment7 (DAC7 output value) [7:0] | | | | | | | | |
| | | | | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | CMD_RS | |
| Addresses other than those above | | | | Setting prohibited | | | | | | | | | | | | |

(Note 1) The notations A, B, in the register map correspond to Ach, Bch respectively.

(Note 2) The Ach is defined as 1ch and 2ch driver output, the Bch as 3ch and 4ch driver output.

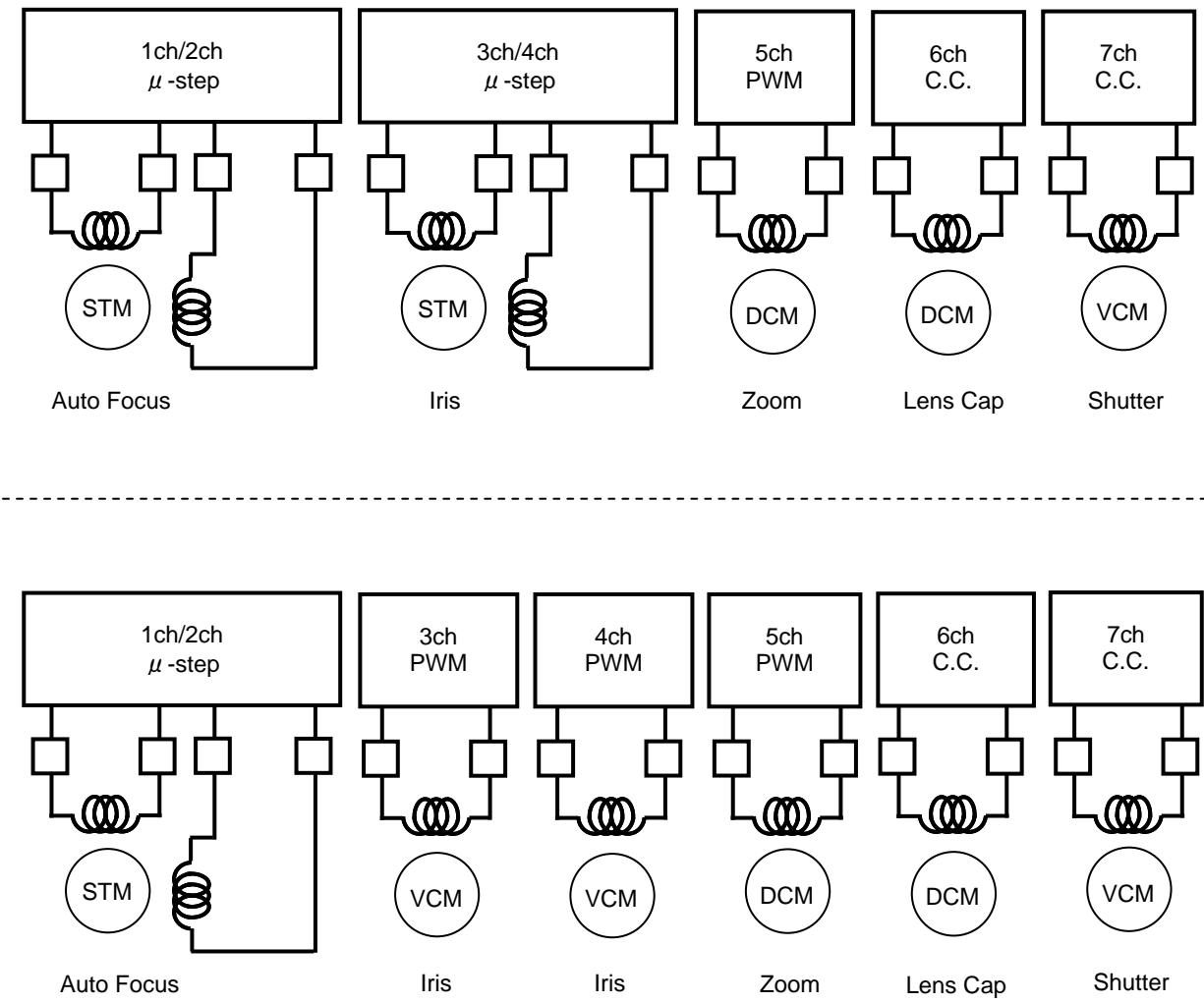
(Note 3) After reset (Power ON reset, and CMD_RS), "initial setting" is saved in all registers.

(Note 4) For Mode, different output voltage, Cycle, En, and Rt registers, data that are written before the access to the Pulse register becomes valid, and determines the rising edge of CSB after the access to the Pulse register.

(The Mode, different output voltage, Cycle, En, and Rt registers contain Cache registers. Any registers other than those do not contain Cache registers.)

(Note 5) For POS, STOP, chop, PWM_Ct, and PWM_duty registers, data are determined at the rising edge of CSB. For any registers other than those, data are determined at the rising edge of 16th SCLK.

●Application Example



●I/O Equivalence Circuit

| Pin | Equivalent Circuit Diagram | Pin | Equivalent Circuit Diagram |
|--|----------------------------|----------------------------------|----------------------------|
| FCLK CSB SCLK SDATA IN7A IN7B | | PIOUT1 PIOUT2 | |
| STATE11 STATE12 STATE21 STATE22 | | OUT1A OUT1B OUT2A OUT2B | |
| OUT3A OUT3B OUT4A OUT4B | | OUT5A OUT5B | |
| OUT6A OUT6B | | OUT7A OUT7B | |

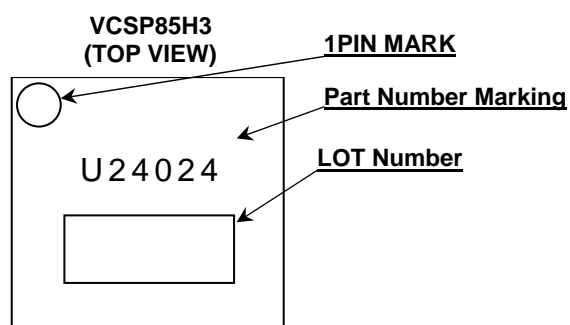
●Operational Notes

- 1) Absolute maximum ratings
If applied voltage, operating temperature range, or other absolute maximum ratings are exceeded, the LSI may be damaged. Do not apply voltages or temperatures that exceed the absolute maximum ratings. If you expect that any voltage or temperature could be exceeding the absolute maximum ratings, take physical safety measures such as fuses to prevent any conditions exceeding the absolute maximum ratings from being applied to the LSI.
- 2) GND potential
The voltage of the ground pin must be the lowest voltage of all pins of the IC at all operating conditions. Ensure that no pins are at a voltage below the ground pin at any time, even during transient condition.
- 3) Thermal design
Use a thermal design that allows for a sufficient margin by taking into account the permissible power dissipation (PD) in actual operating conditions.
- 4) Short circuit between pins and malfunctions
Ensure that when mounting the IC on the PCB the direction and position are correct. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.
- 5) Operation in strong magnetic field
Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.
- 6) Power ON sequence
To turn ON the DVDD, be sure to reset at CMD_RS register.
- 7) Thermal shutdown
The IC incorporates a built-in thermal shutdown circuit, which is designed to turn off the IC when the internal temperature of the IC reaches a specified value. It is not designed to protect the IC from damage or guarantee its operation. Do not continue to operate the IC after this function is activated. Do not use the IC in conditions where this function will always be activated.
- 8) PI drive circuit
The output voltage of PIOOUT should not exceed the voltage of the power supply voltage DVDD.

● Ordering Information

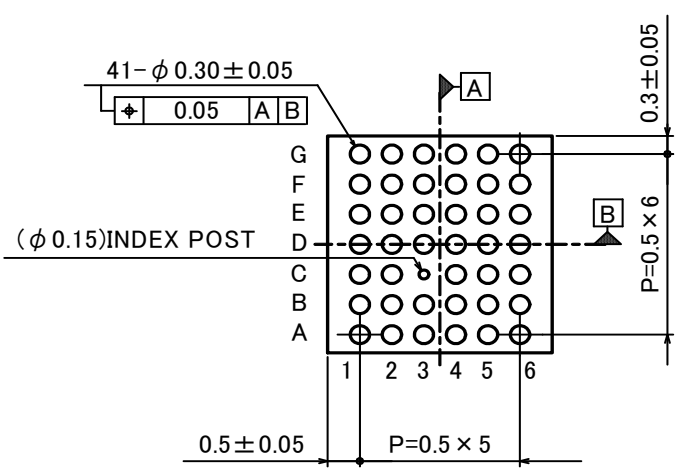
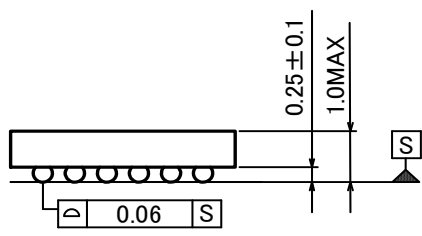
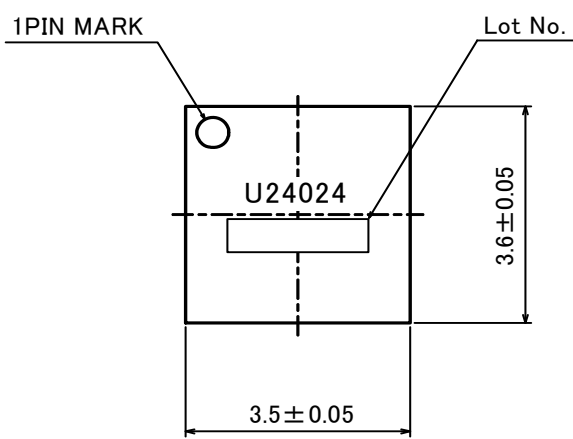
| | | | | | | | | | | |
|-------------------|--|--|--|--|--|--|--|---------------------------|-----|---|
| B U 2 4 0 2 4 G U | | | | | | | | - | E 2 | |
| Part Number | | | | | | | | Package GU VCSP85H3 | : | Packaging and forming specification E2: Embossed tape and reel |

● Marking Diagram

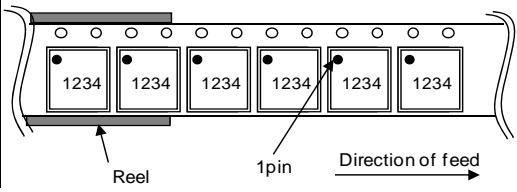


●Physical Dimension Tape and Reel Information

| | |
|--------------|----------|
| Package Name | VCSP85H3 |
|--------------|----------|



| | |
|-------------------|---|
| Tape | Embossed carriertape (heat sealing method) |
| Quantity | 2,500pcs/Real |
| Direction of feed | E2 (The direction is 1pin product is at the upper left when you hold reel on the hand and you pull out the tape on the right hand) |



●Revision History

| Date | Revision | Changes |
|-------------|----------|--|
| 26.Sep.2012 | 001 | New Release |
| 18.Apr.2013 | 002 | Update some English words, sentences, description, grammar and formatting. |

Notice

Precaution on using ROHM Products

- Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

| JAPAN | USA | EU | CHINA |
|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV | | CLASS III | |

- ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - Sealing or coating our Products with resin or other coating materials
 - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since our Products might fall under controlled goods prescribed by the applicable foreign exchange and foreign trade act, please consult with ROHM representative in case of export.

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